



# **BTM420/421 DATA MODULE**

Hardware Integration Guide  
Version 3.3

**global solutions: local support™**

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## REVISION HISTORY

Revision	Date	Description	Approved By
1.0	22 June 2010	Initial Release	Jonathan Kaye
2.0	28 May 2012	Changes and Revisions	Jonathan Kaye
3.0	04 Jan 2013	Formatting, New Hardware Diagrams, FCC Statement updates	Jonathan Kaye
3.1	16 Jan 2014	Changed document name from User Manual to Hardware Integration Guide	Sue White
3.2	05 Feb 2014	Added the Bluetooth SIG Approvals section	Jonathan Kaye
3.3	03 Sept. 2014	Updated EU Declaration of Conformity	Jonathan Kaye

## CONTENTS

<b>1</b>	<b>Overview and Key Features</b>	<b>4</b>
1.1	Features and Benefits  	4
1.2	Application Areas	4
<b>2</b>	<b>Specifications</b>	<b>5</b>
2.1	Detailed Specifications	5
2.2	Pin Definitions	6
2.3	Operating Parameters	8
2.4	Voltage Specifications	8
<b>3</b>	<b>FCC Regulatory Statements</b>	<b>9</b>
3.1	BTM420 FCC and Industry Canada Statements	9
3.2	BTM421 FCC and Industry Canada Statements	10
<b>4</b>	<b>EU Declaration of Conformity – BTM420 / BTM421</b>	<b>11</b>
4.1	Reference Standards used for Presumption of Conformity	11
4.2	Declaration:	11
<b>5</b>	<b>Mechanical Drawings</b>	<b>12</b>
5.1	BTM420 Mechanical Details	12
5.2	BTM420 Mechanical Details	13
5.3	BTM420 Mechanical Details	14
	BTM421 Mechanical Details	15
5.4	BTM421 Mechanical Details	16
5.5	BTM421 Mechanical Details	17
5.6	BTM421 Mechanical Details	18
<b>6</b>	<b>Bluetooth SIG Approvals</b>	<b>19</b>
6.1	Application Note: Subsystem Combinations	19
6.1.1	Laird Customer Declaration ID Procedure	19
6.2	Additional Assistance	20
<b>7</b>	<b>Ordering Information</b>	<b>20</b>
<b>8</b>	<b>General Comments</b>	<b>20</b>

## 1 OVERVIEW AND KEY FEATURES

The BTM420 and BTM421 Bluetooth modules from Laird Technologies have been designed to meet the needs of developers who wish to add robust, short range Bluetooth data connectivity to their products and who are using embedded Bluetooth stacks within their products. They are based on the market leading Cambridge Silicon Radio BC04 chipset, providing exceptionally low power consumption with outstanding range. They support the latest Bluetooth Version 2.1 Specification with EDR (Enhanced Data Rate). As well as increasing data throughput up to 2.1 Mbps, this provides the important advantage of Secure Simple Pairing, which improves security and enhances the ease of use for end customers.

With physical sizes as small as 12.5mm x 18.0mm and best of class, low power performance, these modules are the ideal choice for applications where designers need both performance and minimum size. For maximum flexibility in systems integration, the modules are designed to support separate power supplies for I/O and the USB interface.

These modules present an HCI interface through a USB interface and are fully qualified as Bluetooth Controller Subsystem Products. This allows designers to integrate them existing pre-approved Bluetooth Host and Profile subsystem stacks to gain a Bluetooth END product approval for their product.

A low cost developer's kit is available for prototyping. This ensures that the choice of Laird Technologies Bluetooth modules guarantees the fastest route to market.

### 1.1 Features and Benefits

- Bluetooth v2.1+EDR
- Adaptive Frequency Hopping to cope with interference from other wireless devices
- Support for Secure Simple Pairing
- External or internal antenna options
- HCI Interface over USB
- Bluetooth controller subsystem product qualified
- Compact size
- Class 2 output – 4dBm
- Low power operation
- USB interface
- Multipoint Support
- PCM & SCO for external codec
- Wi-Fi coexistence hardware support

### 1.2 Application Areas

- Embedded devices
- Phone accessories
- Security devices
- Medical and wellness devices
- Automotive applications
- Bluetooth® advertising
- ePOS

## 2 SPECIFICATIONS

### 2.1 Detailed Specifications

Table 1: Detailed Specifications

Categories	Feature	Implementation
Wireless Specification	Bluetooth®	Version 2.1+EDR
	Transmit Class	Class 2
	Frequency	2.402 – 2.480 GHz
	Channels	79 channels Frequency Hopping Adaptive Frequency Hopping
	Max Transmit Power	+4 dBm at antenna pad – BTM420 +4 dBm (TBC) from integrated antenna – BTM421
	Receive Sensitivity	-84dBm
	Range	30m
	Data Transfer Rate	Up to 2.1 Mbps
Antenna Modes	External Antenna	50 Ohm matched SMT pad – BTM420
	Integrated Antenna (option)	+0 dB multiplayer ceramic (TBC) – BTM421
USB Interface	Compliance	Version 1.1
	Support	Version 2.0
	Supply Voltage	3.1 V to 3.3 V
General Purpose Interface	I/O	2 general purpose I.O pins for LEDs
Audio	Support	3 PCM Channels @ 64kbps
	SCO Channels	Support SCO and eSCO
	PCM Interface	Configurable as master or slave 8 bit A-law 8 bit $\mu$ -law 13 bit linear PCM Clock available when in slave mode
Protocols and Firmware	Bluetooth Stack	V2.1 compliant
	Connection Modes	Point to point (cable replacement) Multipoint – max 7 slaves

Table 2: Detailed Specifications

Categories	Feature	Implementation
Current Consumption	Data Transfer	Typically 32 mA
	Low Power Sniff Mode	Less than 2.5 mA
Supply Voltage	Supply	3.0 V – 3.3 V DC
Coexistence / Compatibility	WLAN (802.11)	2-wire and 3-wire hardware coexistence schemes supported
Connections	Interface	Surface Mount Pads

Categories	Feature	Implementation
Physical	External Antenna	Pad for 50 Ohm antenna – BTM420
	Dimensions	12.5 mm x 18.0 mm x 3.4 mm – BTM420 12.5 mm x 24.0 mm x 3.4 mm – BTM421
	Weight	3 grams
Environmental	Operating Temperature	-30°C to +70°C
	Storage Temperature	-40°C to +85°C
Approvals	Bluetooth	Qualified as a Controller Subsystem Product
	FCC	Limited Modular Approval – BTM420 Modular approval (Integrated Antenna option – BTM 421)
	CE & R&TTE	Meets CE and R&TTE requirements
Miscellaneous	Lead free	Lead-free and RoHS compliant
	Warranty	12 Months
Development Tools	Development Kit	Development board

## 2.2 Pin Definitions

Table 3: Pin Definitions

Pin	Signal	Description	Voltage Specification
1	Unused		
2	GND		
3	Unused		
4	Unused		
5	Unused		
6	Unused		
7	GND		
8	SPI_CSB	SPI bus chip select I/P	VIO
9	SPI_MISO	SPI bus serial O/P	VIO
10	SPI_MOSI	SPI bus serial I/P	VIO
11	SPI_CLK	SPI bus clock I/P	VIO
12	VDD_USB	USB & UART supply voltage	
15	GND		
16	PCM_IN	PCM clock I/P	VIO
17	PCM_SYNC	PCM sync I/P	VIO
18	PCM_CLK	PCM click I/P	VIO
19	PCM_OUT	PCM Data O/P	VIO
20	RESET	Module reset I/P	See note 2
21	Unused		
22	GPIO2 / UART_DCD	I/O for host	VIO
23	GND		
24	Unused		

**BTM420/421**

## Bluetooth® Data Module Hardware Integration Guide

Pin	Signal	Description	Voltage Specification
25	Unused		See note 3
26	Unused		See note 3
27	Unused		See note 3
28	GND		See note 3
29	ANT (BTM420)	Antenna connection (50 ohm matched)	See note 3
30	GND		See note 3
31	Unused		See note 3
32	Unused		See note 3
33	Unused		See note 3
34	Unused		See note 3
35	Unused		See note 3
36	Unused		See note 3
37	Unused		See note 3
38	Unused		
39	Unused		
40	Unused		
41	GND		
42	GPIO1 / UART_RI	I/O for hose	VIO
43	Unused		
44	Unused		
45	GND		
46	D-	USB D-	VUSB
47	D+	USB D+	VUSB
48	Unused		
49	Unused		
50	Unused		

1. Unused pins may have internal connections and must not be connected.
2. Reset input is active low. Input is pulled up to VDD\_IN via 22k. Minimum reset pulse width is 5 ms.
3. Pins 25-37 should be left not connected on modules with integrated antennae (BTM411, BTM421 and BTM431)

## 2.3 Operating Parameters

Table 4: Recommended Operating Conditions

Recommended Operating Conditions		
OPERATING CONDITION	MIN	MAX
VDD_USB (USB compatibility not required)	1.7	3.6
VDD_USB (USB compatibility required)	3.1	3.6
VDD_IO	1.7	3.3
VDD_IN	3.0	3.3

## 2.4 Voltage Specifications

Table 5: Logic Levels (VUSB)

Logic Levels (VUSB)			
INPUT VOLTAGE LEVELS	MIN	TYP	MAX
V <sub>ih</sub>	0.7VDD_USB		
V <sub>il</sub> 2.7 < VDD_USB < 3.0	-0.4		+0.8
1.7 < VDD_USB < 1.9	-0.4		+0.4
Output Voltage Levels (1.7 < VDD_USB < 1.9)			
V <sub>oh</sub> (I <sub>out</sub> = -4mA)	VDD_USB – 0.4		
V <sub>ol</sub> (I <sub>out</sub> = 4mA)			
Output Voltage Levels (2.7 < VDD_USB < 3.0)			
V <sub>oh</sub> (I <sub>out</sub> = -4mA)	VDD_USB – 2.0		
V <sub>ol</sub> (I <sub>out</sub> = 4mA)			0.2

Note: VDD\_USB must be connected to power the USB and UART interfaces.

Table 6: Logic Levels (VIO)

Logic Levels (VIO)			
INPUT VOLTAGE LEVELS	MIN	TYP	MAX
V <sub>ih</sub>	0.7VDD_IO		
V <sub>il</sub> 2.7 < VDD_IO < 3.0	-0.4		+0.8
1.7 < VDD_IO < 1.9	-0.4		+0.4
Output Voltage Levels (1.7 < VDD_IO < 1.9)			
V <sub>oh</sub> (I <sub>out</sub> = -4mA)	VDD_IO – 0.4		
V <sub>ol</sub> (I <sub>out</sub> = 4mA)			0.4
Output Voltage Levels (2.7 < VDD_IO < 3.0)			
V <sub>oh</sub> (I <sub>out</sub> = -4mA)	VDD_IO – 0.2		
V <sub>ol</sub> (I <sub>out</sub> = 4mA)			0.2



## 3 FCC REGULATORY STATEMENTS

### 3.1 BTM420 FCC and Industry Canada Statements

The Final Equipment user manual must show the following statements:

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

To comply with the FCC RF exposure compliance requirements, this device and its antenna must not be co-located or operating in conjunction with any other antenna or transmitter.

#### Considerations for OEM integration:

This module has a limited modular approval. Approval with any other antenna configuration or layout other than that approved will necessitate additional radiated emission testing to be performed.

To inherit the modular approval, the antennas for this transmitter must be installed to provide a separation distance of at least 20 cm from all persons and must not be co-located or operating in conjunction with any other antenna or transmitter.

This module was approved with the following antenna:

- RF Solutions: ANT-24G-WHJ-SMA 0 dBi

Operation of this module with any other antenna will require additional testing to be performed.

Co-location with other radio transmitting devices operating concurrently in the same band will require additional testing and certification.

Designers should note the distinction that the FCC makes regarding portable and mobile devices. Mobile devices are defined as products that are not used closer than 20 cm to the human body, whereas portable devices can be used closer than 20 cm to the body. A device may be used in portable exposure conditions with no restrictions on host platforms when the averaged output power is less than the low power threshold for an uncontrolled environment  $\leq 60/f(\text{GHz})$  i.e. 25 mW for a 2.4 GHz device. The Maximum Power Exposure for the BTM420 has been evaluated and found to comply with the low power threshold for an uncontrolled environment.

Refer to FCC document KDB 447498 for more information on RF exposure procedures and equipment authorization policies for mobile and portable devices.

#### FCC Labelling requirement

If the FCC ID is not visible when the module is installed inside another device, then the outside of the device into which the module is installed must also display a label referring to the enclosed module. This exterior label can use wording such as the following: "Contains Transmitter Module FCC ID: PI4420B" or "Contains FCC ID: PI4420B." Any similar wording that expresses the same meaning may be used.

## 3.2 BTM421 FCC and Industry Canada Statements

The user manual must show the following statements:

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

To comply with the FCC RF exposure compliance requirements, this device and its antenna must not be co-located or operating in conjunction with any other antenna or transmitter.

### Considerations for OEM integration:

To inherit the modular approval, the antennas for this transmitter must be installed to provide a separation distance of at least 20 cm from all persons and must not be co-located or operating in conjunction with any other antenna or transmitter.

Co-location with other radio transmitting devices operating concurrently in the same band will require additional testing and certification.

Designers should note the distinction that the FCC makes regarding portable and mobile devices. Mobile devices are defined as products that are not used closer than 20 cm to the human body, whereas portable devices can be used closer than 20 cm to the body. A device may be used in portable exposure conditions with no restrictions on host platforms when the averaged output power is less than the low power threshold for an uncontrolled environment  $\leq 60/f(\text{GHz})$  i.e. 25 mW for a 2.4 GHz device. The Maximum Power Exposure for the BTM421 has been evaluated and found to comply with the low power threshold for an uncontrolled environment.

Refer to FCC document KDB 447498 for more information on RF exposure procedures and equipment authorization policies for mobile and portable devices.

### FCC Labelling requirement

If the FCC ID is not visible when the module is installed inside another device, then the outside of the device into which the module is installed must also display a label referring to the enclosed module. This exterior label can use wording such as the following: "Contains Transmitter Module FCC ID: PI4421B" or "Contains FCC ID: PI4421B." Any similar wording that expresses the same meaning may be used.

## 4 EU DECLARATION OF CONFORMITY – BTM420 / BTM421

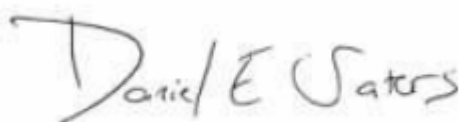
Manufacturer:	Laird
Product:	BTM410 / BTM411 / BTM420 / BTM421 / BTM430 / BTM431 / BTM441 / BTM443 / BTM461
EU Directive:	RTTE 1995/5/EC
Conformity Assessment:	Annex IV

### 4.1 Reference Standards used for Presumption of Conformity

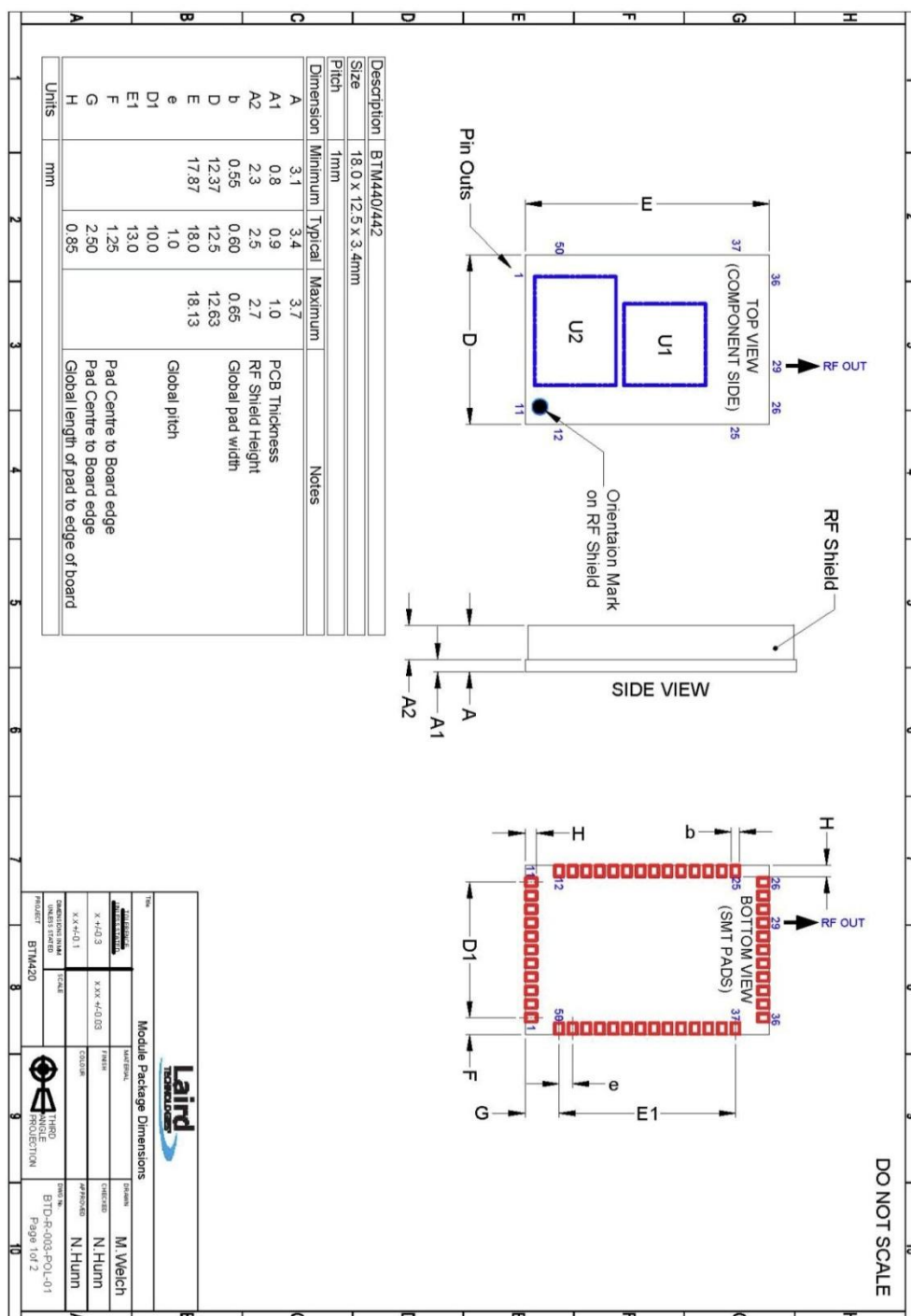
Article Number	Requirement	Reference standard(s)
3.1a	Health and Safety	EN 60950-1:2005 (2 <sup>nd</sup> Ed); +Am1:2009 +Am2:2013 EN 60950-1:2006+A11+a1:2010+A12:2011+A2:2013
3.1a	RF Exposure	EN 62479:2010
3.1b	Protection requirements with respect to electromagnetic compatibility	EN 301 489-1 V1.9.2 (2011-09) EN 301 489-17 V2.2.1 (2012-09) Emissions: EN55022:2010 /AC:2011 (ClassB) Immunity: EN61000-4-2:2009 EN61000-4-3:2006 /A1:2008 /A2:2010
3.2	Means of the efficient use of the radio frequency spectrum	EN 300 328 V1.8.1 (2012-06)

### 4.2 Declaration:

We, Laird, declare under our sole responsibility that the essential radio test suites have been carried out and that the above product to which this declaration relates is in conformity with all the applicable essential requirements of Article 3 of the EU Directive 1995/5/EC, when used for its intended purpose.

Place of Issue:	Laird 11160 Thompson Ave. Lenexa, KS 66219
Date of Issue:	October 2009
Name of Authorized Person:	Daniel Waters / Certifications Specialist
Signature:	

## 5.1 BTM420 Mechanical Details



Note: An area of 1.5 mm around the module should be reserved as a keep-out area.

# PCB LAND PATTERN/DECAL DIMENSIONS

DO NOT SCALE

## MODULE OUTLINE

(See note 2)

## Notes

- 1: Connect External Antenna to RF I/O pin 29 with 50ohm microstrip or coplanar waveguide.
- 2: Ensure no exposed copper under module to avoid shorting to test points on underside of module.
- 3: The user may modify the PCB land pattern dimensions based on their experience and/or process capability.

Recommended Land Pattern/Decal			
THICKNESS	LAND PATTERN	THICKNESS	LAND PATTERN
0.005	0.005	0.005	0.005
0.010	0.010	0.010	0.010
0.015	0.015	0.015	0.015
0.020	0.020	0.020	0.020
0.025	0.025	0.025	0.025
0.030	0.030	0.030	0.030
0.035	0.035	0.035	0.035
0.040	0.040	0.040	0.040
0.045	0.045	0.045	0.045
0.050	0.050	0.050	0.050
0.055	0.055	0.055	0.055
0.060	0.060	0.060	0.060
0.065	0.065	0.065	0.065
0.070	0.070	0.070	0.070
0.075	0.075	0.075	0.075
0.080	0.080	0.080	0.080
0.085	0.085	0.085	0.085
0.090	0.090	0.090	0.090
0.095	0.095	0.095	0.095
0.100	0.100	0.100	0.100
0.105	0.105	0.105	0.105
0.110	0.110	0.110	0.110
0.115	0.115	0.115	0.115
0.120	0.120	0.120	0.120
0.125	0.125	0.125	0.125
0.130	0.130	0.130	0.130
0.135	0.135	0.135	0.135
0.140	0.140	0.140	0.140
0.145	0.145	0.145	0.145
0.150	0.150	0.150	0.150
0.155	0.155	0.155	0.155
0.160	0.160	0.160	0.160
0.165	0.165	0.165	0.165
0.170	0.170	0.170	0.170
0.175	0.175	0.175	0.175
0.180	0.180	0.180	0.180
0.185	0.185	0.185	0.185
0.190	0.190	0.190	0.190
0.195	0.195	0.195	0.195
0.200	0.200	0.200	0.200
0.205	0.205	0.205	0.205
0.210	0.210	0.210	0.210
0.215	0.215	0.215	0.215
0.220	0.220	0.220	0.220
0.225	0.225	0.225	0.225
0.230	0.230	0.230	0.230
0.235	0.235	0.235	0.235
0.240	0.240	0.240	0.240
0.245	0.245	0.245	0.245
0.250	0.250	0.250	0.250
0.255	0.255	0.255	0.255
0.260	0.260	0.260	0.260
0.265	0.265	0.265	0.265
0.270	0.270	0.270	0.270
0.275	0.275	0.275	0.275
0.280	0.280	0.280	0.280
0.285	0.285	0.285	0.285
0.290	0.290	0.290	0.290
0.295	0.295	0.295	0.295
0.300	0.300	0.300	0.300
0.305	0.305	0.305	0.305
0.310	0.310	0.310	0.310
0.315	0.315	0.315	0.315
0.320	0.320	0.320	0.320
0.325	0.325	0.325	0.325
0.330	0.330	0.330	0.330
0.335	0.335	0.335	0.335
0.340	0.340	0.340	0.340
0.345	0.345	0.345	0.345
0.350	0.350	0.350	0.350
0.355	0.355	0.355	0.355
0.360	0.360	0.360	0.360
0.365	0.365	0.365	0.365
0.370	0.370	0.370	0.370
0.375	0.375	0	

Embedded Wireless Solutions Support  
Center: <http://ews-support.lairdtech.com>  
[www.lairdtech.com/bluetooth](http://www.lairdtech.com/bluetooth)

**BOTTOM VIEW**  
(SMT PADS)

Test Points are 1mm x 1mm.

**DO NOT SCALE**

Embedded Wireless Solutions Support  
Center: <http://ews-support.lairdtech.com>  
[www.lairdtech.com/bluetooth](http://www.lairdtech.com/bluetooth)

[illegible]

**Note:** An area of 1.5 mm around the module should be reserved as a keep-out area.

[illegible]

**Note:** An area of 1.5 mm around the module should be reserved as a keep-out area.



## 5.5 BTM421 Mechanical Details

APPLICATION NOTES

DO NOT SCALE

- 1.) Ensure there is no copper in the antenna keep out area on any layers of the host p.c. board. Also keep all mounting hardware or any metal clear of this area to prevent affecting proper antenna radiation.
- 2.) For best antenna performance the module should be placed on the edge of the host p.c. board and preferably in the corner with the antenna facing the corner.
- 3.) Antenna keep out area definition comes from the module's Developer Kit board which was used for module development and antenna performance evaluation.
- 4.) Ensure no exposed copper under module on host p.c. board to avoid shorting to test points on underside of module.
- 5.) The user may modify the PCB land pattern dimensions based on their experience and/or process capability.

Title			
Application Notes		M. Welch	
Author	DATE	Checked	DATE
X.X.X-0.0.0	X.X.X-0.0.0	N. Humm	
X.X.X-0.0.1	X.X.X-0.0.1	N. Humm	
Revision	DATE	Checked	DATE
BTM421	BTM421	N. Humm	
Project	BTM421	BTM421	
THIRD PROVISION			
BTM421			

Page 3 of 3

**BOTTOM VIEW**  
(SMT PADS)

Test Points are 1mm x 1mm.

26.0 26.0

26 26

25 37

5 15 11 14

6 21 13

3 18 9 12

4 10 8 7

2 17

1 1

2.6 4.6 6.6 8.6

9.35 7.35 5.35 3.35

**BTM421**

**Laird**  
TECHNOLOGIES

Module Test Point Locations			
REF	TEST POINT	TEST POINT	TEST POINT
1	26	26	26
2	25	37	37
3	18	9	12
4	10	8	7
5	15	11	14
6	21	13	
7	17		
8	1		
9	12		
10	8		
11	14		
12	9		
13	21		
14	11		
15	5		
16	6		
17	2		
18	3		
19	6		
20	5		
21	6		
22	5		
23	4		
24	3		
25	2		
26	1		

**WARNING:** Test point dimensions are for reference only. *DO NOT* make electrical connections to these test points, this will void the warranty. Laird does not recommend routing on the top layer underneath the module.

The Development Kit Schematics for this product can be accessed from the software downloads tab of the [BTM42x Product Page](#)

## 6 BLUETOOTH SIG APPROVALS

### 6.1 Application Note: Subsystem Combinations

This application note covers the procedure for generating a new Declaration ID for a Subsystem combination on the Bluetooth SIG website. In the instance of subsystems, a member can combine two or more subsystems to create a complete Bluetooth End Product solution.

Subsystem listings referenced as an example:

Design Name	Owner	Declaration ID	Link to listing on the SIG website
BT800	Laird	B016072	<a href="https://www.bluetooth.org/tpg/QLI_viewQDL.cfm?qid=16072">https://www.bluetooth.org/tpg/QLI_viewQDL.cfm?qid=16072</a>
Windows 8 (Host Subsystem)	Microsoft Corporation	B012854	<a href="https://www.bluetooth.org/tpg/QLI_viewQDL.cfm?qid=12854">https://www.bluetooth.org/tpg/QLI_viewQDL.cfm?qid=12854</a>

#### 6.1.1 Laird Customer Declaration ID Procedure

This procedure assumes that the member is simply combining two subsystems to create a new design, without any modification to the existing, qualified subsystems. This is achieved by using the Listing interface on the Bluetooth SIG website. Figure 1 shows the basic subsystem combination of a controller and host subsystem. The Controller provides the RF/BB/LM and HCI layers, with the Host providing L2CAP, SDP, GAP, RFCOMM/SPP and any other specific protocols and profiles existing in the Host subsystem listing. The design may also include a Profile Subsystem.

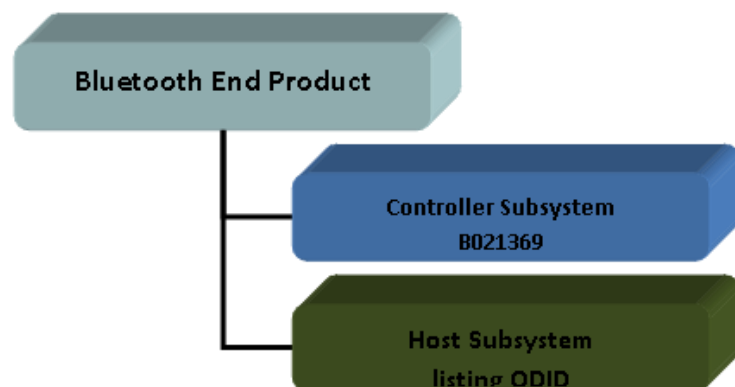


Figure 1: Basic subsystem combination of a controller and host subsystem

The Qualification Process requires each company to registered as a member of the Bluetooth SIG –

<http://www.bluetooth.org>

The following link provides a link to the Bluetooth Registration page:

<https://www.bluetooth.org/login/register/>

For each Bluetooth Design it is necessary to purchase a Declaration ID. This can be done before starting the new qualification, either through invoicing or credit card payment. The fees for the Declaration ID will depend on your membership status, please refer to the following webpage:

<https://www.bluetooth.org/en-us/test-qualification/qualification-overview/fees>

For a detailed procedure of how to obtain a new Declaration ID for your design, please refer to the following SIG document:

[https://www.bluetooth.org/DocMan/handlers/DownloadDoc.ashx?doc\\_id=283698&vld=317486](https://www.bluetooth.org/DocMan/handlers/DownloadDoc.ashx?doc_id=283698&vld=317486)

To start the listing, go to: [https://www.bluetooth.org/tpg/QLI\\_SDoc.cfm](https://www.bluetooth.org/tpg/QLI_SDoc.cfm).

## BTM420/421

### Bluetooth® Data Module Hardware Integration Guide

In step 1, select the option, 'Reference a Qualified Design', and enter the Declaration IDs of each subsystem used in the End Product design. You can then select your pre-paid Declaration ID from the drop down menu or go to the Purchase Declaration ID page, (please note that unless the Declaration ID is pre-paid or purchased with a credit card, it will not be possible to proceed until the SIG invoice is paid.

Once all the relevant sections of step 1 are complete, complete steps 2, 3, and 4 as described in the help document. Your new Design will be listed on the SIG website and you can print your Certificate and DoC.

For further information please refer to the following training material:

<https://www.bluetooth.org/en-us/test-qualification/qualification-overview/listing-process-updates>

## 6.2 Additional Assistance

Please contact your local sales representative or our support team for further assistance:

Laird Technologies Connectivity Products Business Unit

Support Centre: <http://ews-support.lairdtech.com>

Email: [wireless.support@lairdtech.com](mailto:wireless.support@lairdtech.com)

Phone: Americas: +1-800-492-2320 Option 2

Europe: +44-1628-858-940

Hong Kong: +852 2923 0610

Web: <http://www.lairdtech.com/bluetooth>

## 7 ORDERING INFORMATION

Part Number	Description
BTM420	Bluetooth AT Data Module (external antenna)
BTM421	Bluetooth AT Data Module (with integrated antenna)
DVK – BTM420	Development board with BTM420 module soldered in place
DVK – BTM421	Development board with BTM421 module soldered in place

## 8 GENERAL COMMENTS

All information in this document is subject to change. Please check with Laird Technologies for the latest information before commencing a design. If in doubt, ask.

Refer to the schematic BTMD-R-001.pdf for the Development Kit on the following two pages for examples of typical pin connections. A PDF of the schematic can be downloaded from the product web page.



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- Data Communications
- Automotive Electronics
- Computers
- Aerospace
- Military
- Medical Equipment
- Consumer Electronics

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